PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Sameer Vermani	05/23/2012
Santosh P. Abraham	05/23/2012
Mohammad Hossein Taghavi Nasrabadi	05/16/2012
Vincent K. Jones	06/04/2012
Hemanth Sampath	06/11/2012

RECEIVING PARTY DATA

Name:	QUALCOMM Incorporated	
Street Address:	5775 Morehouse Drive	
Internal Address:	Patent Department/Central Administration	
City:	San Diego	
State/Country:	CALIFORNIA	
Postal Code:	92121	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13466978

CORRESPONDENCE DATA

Fax Number: (858)658-2502 Phone: 858-845-4265

patent.docketing.us@qualcomm.com Email:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: QUALCOMM INCORPORATED Address Line 1: 5775 MOREHOUSE DR.

Address Line 4: SAN DIEGO, CALIFORNIA 92121

111704U3 ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER:	Audrey Fontanilla
Total Attachments: 6 source=111704U3_Assignment_20120614# source=111704U3_Assignment_20120614# source=111704U3_Assignment_20120614# source=111704U3_Assignment_20120614# source=111704U3_Assignment_20120614# source=111704U3_Assignment_20120614#	page2.tif page3.tif page4.tif page4.tif page4.tif

ASSIGNMENT

WHEREAS, WE,

- 1. Sameer Vermani, a citizen of India, having a mailing address located at 5775 Morehouse Drive and a resident of San Diego, CA,
- Santosh P. Abraham, a citizen of the United States of America having a mailing address located at 5775 Morehouse Drive and a resident of San Diego, CA,
- Mohammad Hossein Taghavi Nasrabadi, a citizen of Iran, having a mailing address located at 5775 Morehouse Drive and a resident of San Diego, CA,
- 4. Vincent K. Jones, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive and a resident of Redwood City, CA,
- 5. Hemanth Sampath, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to SYSTEMS AND METHODS FOR WIRELESS COMMUNICATION OF PACKETS HAVING A PLURALITY OF FORMATS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/466,978 filed May 8, 2012, Qualcomm Reference No. 111704U2, and all applications relating thereto together with U.S. Provisional Application No. 61/486,107, filed May 13, 2011, Qualcomm Reference No. 111704P1, U.S. Provisional Application No. 61/488,714, filed May 21, 2011, Qualcomm Reference No. 111704P2, U.S. Provisional Application No. 61/577,442, filed December 19, 2011, Qualcomm Reference No. 111704P3, U.S. Provisional Application No. 61/580,613, filed December 27, 2011, Qualcomm Reference No. 111704P4, U.S. Provisional Application No. 61/585,557, filed

January 11, 2012, Qualcomm Reference No. 111704P5 (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof:

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	LOCATION On	05/23/2012	Daniel Comment
	LOCATION	DATE	Sameer Vermani
Done at	San Dego, on LOCATION	Slas horz	h dil
	LOCATION	DATE	Santosh P. Abraham
Done at _.	LOCATION	DATE	Mohammad Hossein Taghavi Nasrabadi
Done at	LOCATION, on	DATE	Vincent K. Jones
Done at	LOCATION	DATE	Hemanth Samnath

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Done at	, on		
	LOCATION on	DATE	Sameer Vermani
Done at	LOCATION		
	LOCATION	DATE	Santosh P. Abraham
Done at <u>Se</u> m	Diego, (4, on 5, LOCATION	î 16/2012	JANA!
	LOCATION	DATE	Mohammad Hossein Taghavi Nasrabadi
Done at	, on	Salah (2017)	
	LOCATION	DATE	Vincent K. Jones
Done at	no,		
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	LOCATION	DATE	Hemanth Samnath

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Done at	, on		
	LOCATION , on	DATE	Sameer Vermani
Done at _	LOCATION on		
	LOCATION	DATE	Santosh P. Abraham
Done at	LOCATION on		
	LOCATION	DATE	Mohammad Hossein Taghavi Nasrabadi
Lest. Done at _	LOCATION On_	Ca/4/2012	<u>G4. ~</u>
	LOCATION	DATE	Vincent R. Jones
Done at _	, on		
	LOCATION	DATE	Hemanth Samnath

QUALCOMM Ref. No. 111704U3 Page 3 of 3

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _		, on		
	LOCATION		DATE	Sameer Vermani
Done at	LOCATION	, on		
	LOCATION		DATE	Santosh P. Abraham
Done at	:	, on		
	LOCATION		DATE	Mohammad Hossein Taghavi Nasrabadi
Done at		. On		
	LOCATION	, 0	DATE	Vincent K. Jones
Done at	San Digo	on O	6/11/12	Hemanth Sampath
•	LOCATION	* ************************************	DATE	Hemanth Sampath

PATENT REEL: 028375 FRAME: 0456

RECORDED: 06/14/2012